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11/27/01
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Basceri et al.

Art Unit: --

Application No. --

Filed: Herewith

For: METHODS FOR FORMING AND
INTEGRATED CIRCUIT STRUCTURES
CONTAINING ENHANCED-SURFACE-AREA
CONDUCTIVE LAYERS

Examiner: --

Date: September 26, 2001

PATENT APPLICATION
COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

PRELIMINARY AMENDMENT

Before calculating the filing fee for the above-named divisional patent application, please amend the application as follows:

In the specification:

Before page 1, line 4, please insert the following:

Cross Reference to Related Applications

This application is a division of Application No. 09/590,791, filed June 8, 2000.

now US Patent No. 6,482,736

In the claims:

Cancel claims 1-29 without prejudice.

09565509-092601

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